

## **LOGIBEC GROUPE INFORMATIQUE LTEE.**

- 1.1:Communications Technology:Telecommunications Networking
- 1.2:Communications Technology:Transmission Media
- 1.3:Communications Technology:Modulation and Encoding
- 1.4:Communications Technology:Switching and Multiplexing
- 3.1:Communications Networks :Computer Communications Protocols
- 3.2:Communications Networks :ISDN
- 3.3:Communications Networks :Local Area Networks
- 3.6:Communications Networks :Communications Network Mgmt.
- 4.1:Office Automation Systems:Text and Graphics Creation, Manip
- 4.2:Office Automation Systems:Database Management
- 4.3:Office Automation Systems:Electronic Mail and Messaging
- 4.4:Office Automation Systems:Elec File Trans & Decision Support
- 5.1:Computer Systems and Apps:Image Recognition and Processing
- 5.2:Computer Systems and Apps:Voice Recognition
- 5.3:Computer Systems and Apps:Dist and Par Processing Systems
- 6.1:Software Automation :Rel Database Storage and Retrieval
- 6.2:Software Automation :Computer Aided Educ and Inst
- 6.3:Software Automation :Computer Aided Design and Mfg
- 6.4:Software Automation :Computer Integrated Manufacturing
- 6.7:Software Automation :Electronic Publishing
- 7.1:Human-Machine Interface :Intelligent Input/Output
- 7.2:Human-Machine Interface :Speech Recognition
- 7.4:Human-Machine Interface :Visual Pattern Recognition

## **LEIGH INSTRUMENTS LIMITED**

- 2.3:Communications Systems :Mobile Communications System

## **LINDSAY SPECIALTY PRODUCTS LTD.**

- 1.2:Communications Technology:Transmission Media
- 1.3:Communications Technology:Modulation and Encoding
- 2.1:Communications Systems :Radio and Tv Broadcast Systems
- 2.2:Communications Systems :Communications Satellite System
- 2.3:Communications Systems :Mobile Communications System
- 3.3:Communications Networks :Local Area Networks
- 3.5:Communications Networks :Broadband Networks for Video, FAX
- 8.2:Cmpnts, Devices,materials:Optical and Optoelectronic Devices
- 8.3:Cmpnts, Devices,materials:Sensors and Transducers

## **LINEAR SYSTEMS LTD.**

- 3.3:Communications Networks :Local Area Networks
- 7.1:Human-Machine Interface :Intelligent Input/Output
- 8.1:Cmpnts, Devices,materials:Micro-Electronics